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Fairchild Semiconductor FQI13N50CTU

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November 2013

FQI13N50C

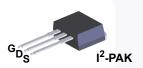
N-Channel QFET $^{\rm @}$ MOSFET 500 V, 13 A, 480 m Ω

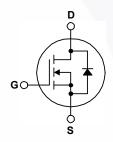
Features

- 13 A, 500 V, $R_{DS(on)}$ = 480 m Ω (Max.) @ V_{GS} = 10 V, I_D = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- · 100% Avalanche Tested
- · RoHS Compliant

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQI13N50CTU	Unit
V_{DSS}	Drain-Source Voltage		500	V
I _D	Drain Current - Continuous (T _C = 25°C)		13	А
	- Continuous (T _C = 100°C)		8	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	52	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	860	mJ
I _{AR}	Avalanche Current	(Note 1)	13	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	19.5	mJ
dv/dt	Peak Diode Recovery dv/dt (No		4.5	V/ns
P_{D}	Power Dissipation (T _C = 25°C) - Derate above 25°C		195	W
			1.56	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C
'L			300	

Thermal Characteristics

Symbol	Parameter	FQI13N50CTU	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.64	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	



Datasheet of FQI13N50CTU - MOSFET N-CH 500V 13A I2PAK
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Package Marking and Ordering Information

Device Marking	Marking Device Package		Reel Size	Tape Width	Quantity	
FQI13N50C	FQI13N50CTU	I ² -PAK	Tube	N/A	50 units	

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	500			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 400 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 6.5 A		0.39	0.48	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 6.5 A	\	15		S
Dynami C _{iss}	ic Characteristics Input Capacitance			1580	2055	pF
C _{oss}	Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		180	235	pF
C _{rss}	Reverse Transfer Capacitance	1 – 1.0 MHZ		20	25	pF
	·					
	ng Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250 V, I _D = 13 A,		25	60	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		100	210	ns
t _{d(off)}	Turn-Off Delay Time	(Note 4)		130	270	ns
t _f	Turn-Off Fall Time			100	210	ns
Q _g	Total Gate Charge	V _{DS} = 400 V, I _D = 13 A,		43	56	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		7.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		18.5		nC
Drain-S	ource Diode Characteristics ar	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				13	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	sed Drain-Source Diode Forward Current			52	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 13 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 13 A,		410		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		4.5	_	μС

NOTES

- 1. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 2. L =6.0 mH, I_{AS} = 13A, V_{DD} = 50V, R_{G} = 25 Ω , starting T_{J} = 25°C.
- 3. $I_{SD} \leq$ 13A, di/dt \leq 200A/ μ s, $V_{DD} \leq$ BV $_{DSS}$, starting T_J = 25°C.
- 4. Essentially independent of operating temperature.



Typical Characteristics

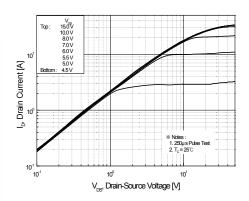


Figure 1. On-Region Characteristics

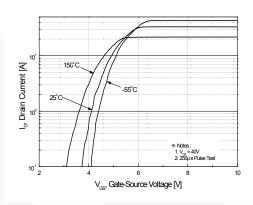


Figure 2. Transfer Characteristics

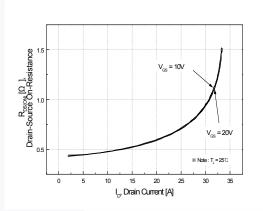


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

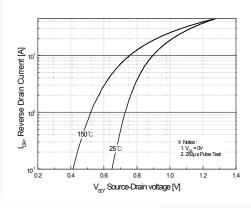


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

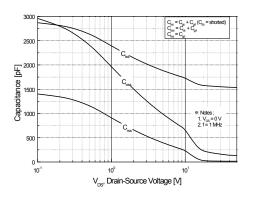


Figure 5. Capacitance Characteristics

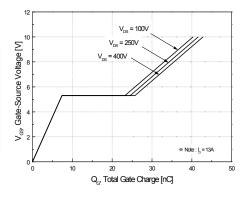
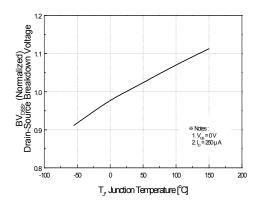


Figure 6. Gate Charge Characteristics



Package Dimensions (Continued)



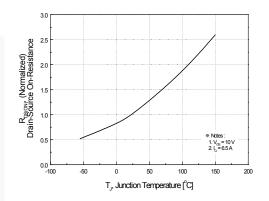
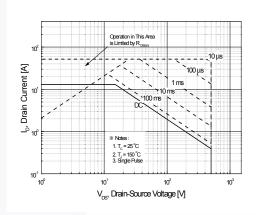


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



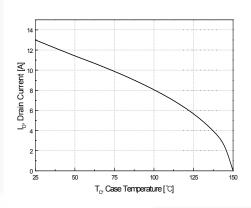


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

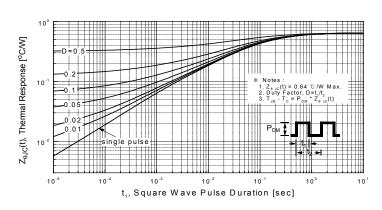


Figure 11. Transient Thermal Response Curve



Figure 12. Gate Charge Test Circuit & Waveform

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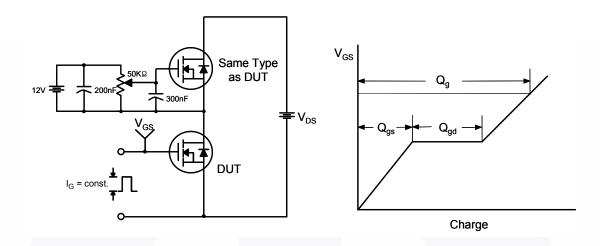


Figure 13. Resistive Switching Test Circuit & Waveforms

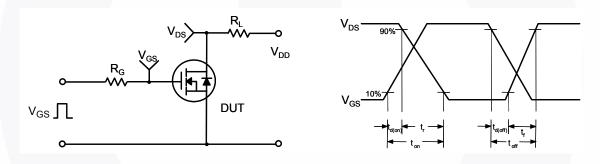
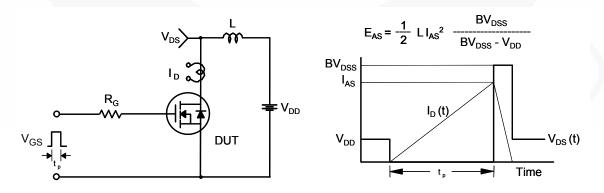


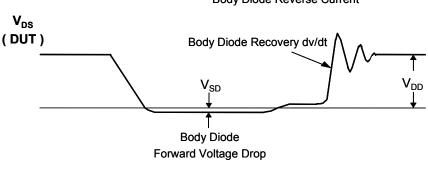
Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



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Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms DUT I SD a Driver Same Type as DUT V_{DD} • dv/dt controlled by R_G • \mathbf{I}_{SD} controlled by pulse period Gate Pulse Width V_{GS} Gate Pulse Period 10V (Driver) \mathbf{I}_{FM} , Body Diode Forward Current I_{SD} di/dt (DUT) I_{RM} **Body Diode Reverse Current**





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Mechanical Dimensions

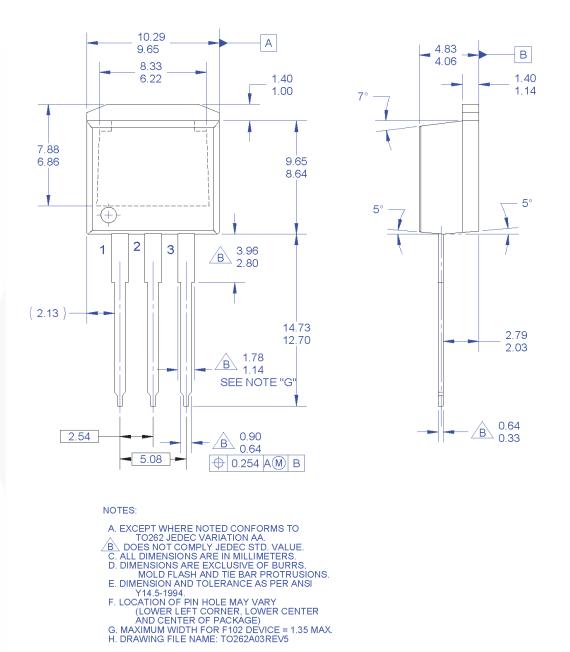


Figure 16. TO262 (I²PAK), Molded, 3-Lead, Jedec Variation AA

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Datasheet of FQI13N50CTU - MOSFET N-CH 500V 13A I2PAK

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